

N-channel 800 V, 0.470 Ω typ., 9 A MDmesh[™] K5 Power MOSFETs in a TO-220FP and TO-220FP ultra narrow leads

Datasheet - production data

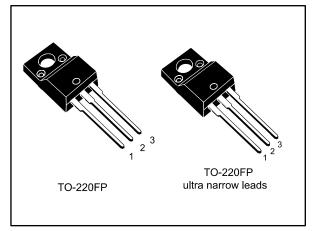
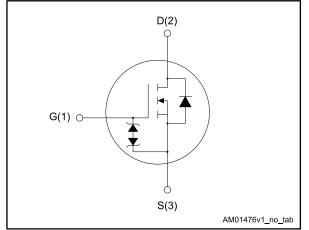


Figure 1: Internal schematic diagram



Features

Order code	VDS	RDS(on) max.	ΙD	Ртот
STF10N80K5	800 V	0.600 Ω	9 A	30 W
STFU10N80K5	800 V			30 W

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

These very high voltage N-channel Power MOSFETs are designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STF10N80K5	10N80K5	TO-220FP	
STFU10N80K5	TUNOUKS	TO-220FP ultra narrow leads	Tube

DocID026564 Rev 5

www.st.com

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter		Unit
Vgs	Gate-source voltage	± 30	V
ID ⁽¹⁾	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	9	А
I _D ⁽¹⁾	Drain current (continuous) at T _c = 100 °C	6	А
I _{DM} ⁽²⁾	Drain current pulsed	36	А
P _{TOT}	Total dissipation at $T_C = 25 \text{ °C}$	30	W
I _{AR}	Max. current during repetitive or single pulse avalanche (pulse width limited by T_{jmax})	3	А
Eas	Single pulse avalanche energy (starting T_J = 25 °C, I_D = $I_{AS},$ V_{DD} = 50 V)	130	mJ
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_c = 25$ °C)	2500	V
dv/dt ⁽³⁾	Peak diode recovery voltage slope	4.5	\//~~~
dv/dt (4)	dv/dt ⁽⁴⁾ MOSFET dv/dt ruggedness		V/ns
Tj	Operating junction temperature range	- 55 to 150	
T _{stg}			°C

Notes:

⁽¹⁾Limited by maximum junction temperature.

⁽²⁾Pulse width limited by safe operating area.

 $^{(3)}I_{SD} \leq 9$ A, di/dt \leq 100 A/µs; V_Ds peak \leq V(BR)DSS

 $^{(4)}V_{DS} \le 640 \text{ V}$

Table 3: Thermal data

Symbol Parameter		Value	Unit
R _{thj} -case	Rthj-case Thermal resistance junction-case		
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W



2 Electrical characteristics

 $T_C = 25$ °C unless otherwise specified

Table 4: On/off-state								
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
V(BR)DSS	Drain-source breakdown voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	800			V		
	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 800 V$			1	μA		
IDSS		$V_{GS} = 0 V, V_{DS} = 800 V$ T _C = 125 °C ⁽¹⁾			50	μA		
I _{GSS}	Gate body leakage current	V_{DS} = 0 V, V_{GS} = ±20 V			±10	μΑ		
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \ \mu A$	3	4	5	V		
R _{DS(on)}	Static drain-source on-resistance	V_{GS} = 10 V, I_D = 4.5 A		0.470	0.600	Ω		

Notes:

⁽¹⁾Defined by design, no subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	635	-	pF
Coss	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	53	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0 V		0.8	-	рF
Co(tr) ⁽¹⁾	Equivalent capacitance time related		-	85	-	рF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	V _{DS} = 0 to 640 V, V _{GS} = 0 V		34	-	pF
Rg	Intrinsic gate resistance	$f = 1 MHz$, $I_D = 0 A$	-	6	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 9 \text{ A}$	-	22	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	5.5	-	nC
Q _{gd}	Gate-drain charge	See Figure 16: "Test circuit for gate charge behavior"	-	13.2	-	nC

Table 5: Dynamic

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS} .

 $^{(2)}\mathsf{E}\mathsf{nergy}$ related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_Ds increases from 0 to 80% V_Dss.



Electrical characteristics

	Table 6: Switching times								
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit			
t _{d(on)}	Turn-on delay time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 4.5 \text{ A}, \text{ R}_{G} = 4.7 \Omega$	-	14.5	-	ns			
tr	Rise time	$V_{GS} = 400$ V, $D = 4.5$ A, $R_G = 4.7$ Ω V _{GS} = 10 V See Figure 15: "Test circuit for		11	-	ns			
t _{d(off)}	Turn-off delay time	resistive load switching times" and Figure 20: "Switching time waveform"	-	35	-	ns			
t _f	Fall time		-	14	-	ns			

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		9	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		36	А
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 9 A, V _{GS} = 0 V	-		1.5	V
trr	Reverse recovery time	I _{SD} = 9 A, di/dt = 100 A/µs,	-	370		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V, see Figure 17: "Test circuit for inductive load switching and diode	-	4.58		μC
I _{RRM}	Reverse recovery current	recovery times")		25		А
trr	Reverse recovery time	$I_{SD} = 9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	520		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 ^{\circ}\text{C}$ see Figure 17: "Test circuit for inductive	-	5.88		μC
IRRM	Reverse recovery current	load switching and diode recovery times"		22.5		А

Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$ width limited by safe operating area.

 $^{(2)}$ Pulsed: pulse duration = 300 µs, duty cycle 1.5%.

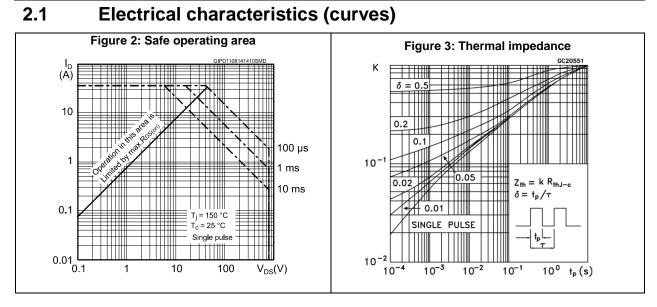
Table 8: Gate-source Zener diode

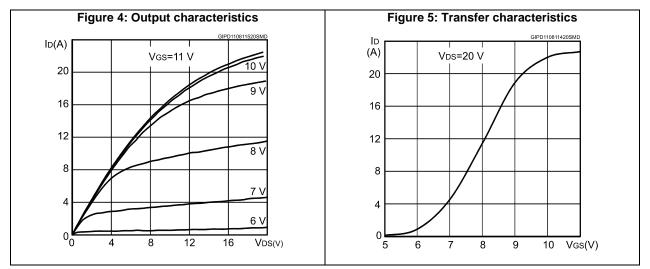
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V (BR)GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



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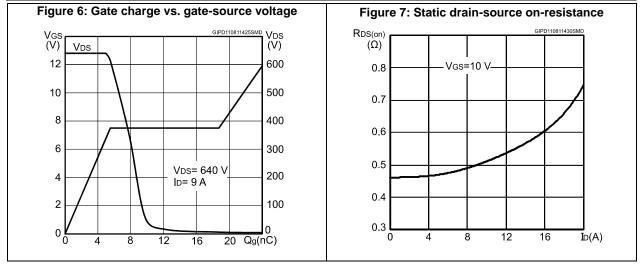




Electrical characteristics

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T_J=150 °C



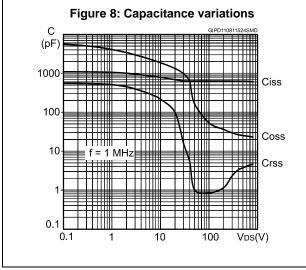
Vsd (V)

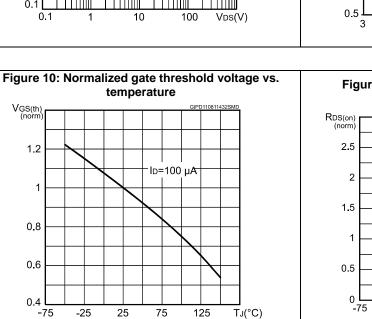
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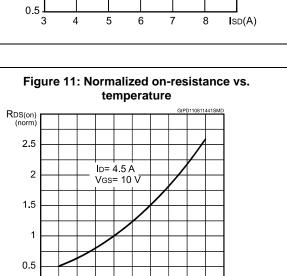
0.8

0.7

0.6







-25

25

75

125

TJ(°C)

Figure 9: Source-drain diode forward

characteristics

TJ=25 °C

TJ=-50 °C

57

VGS(th) (norm)

1.2

1

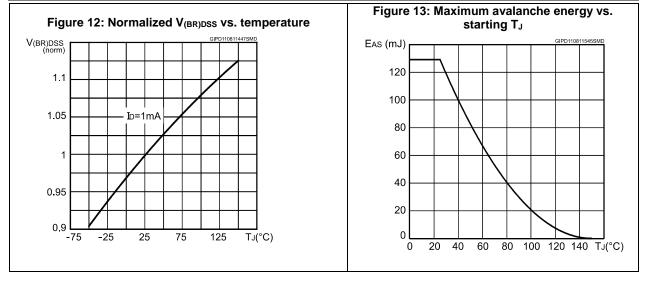
0.8

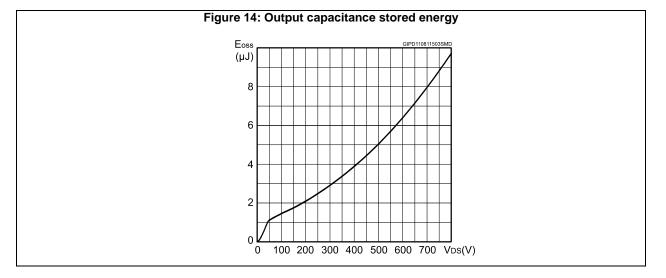
0.6

0.4

Electrical characteristics

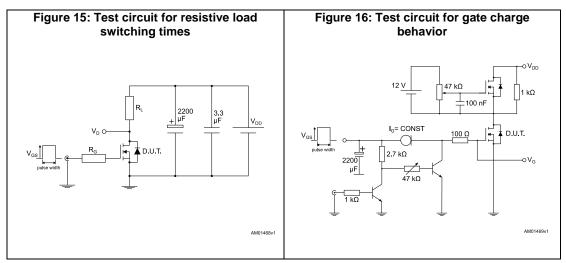
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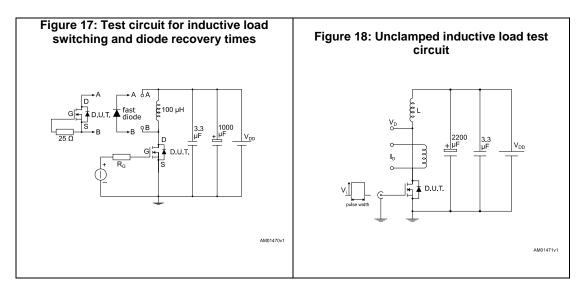






3 Test circuits

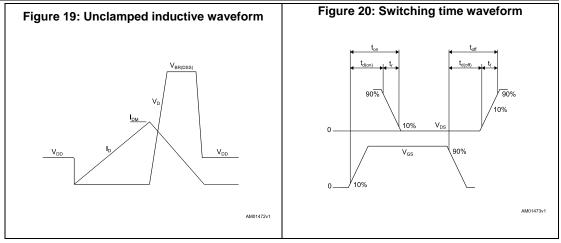






Test circuits

STF10N80K5, STFU10N80K5



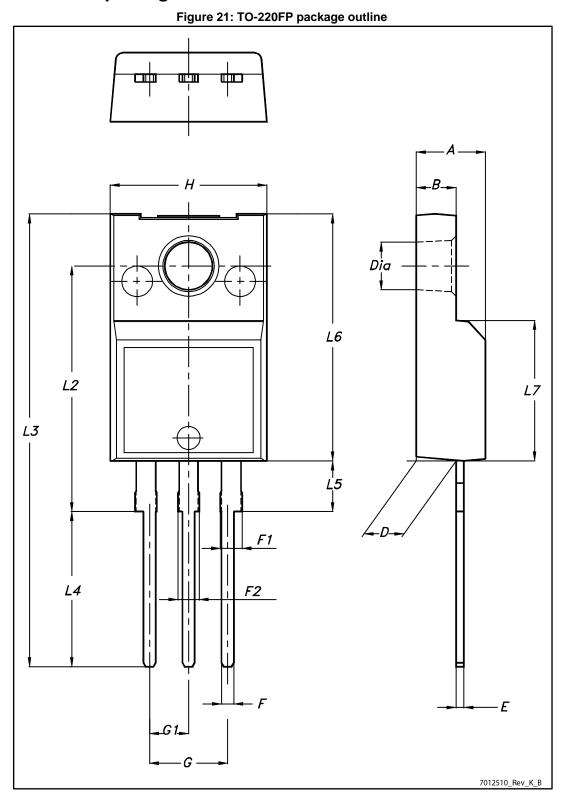


4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



4.1 TO-220FP package information



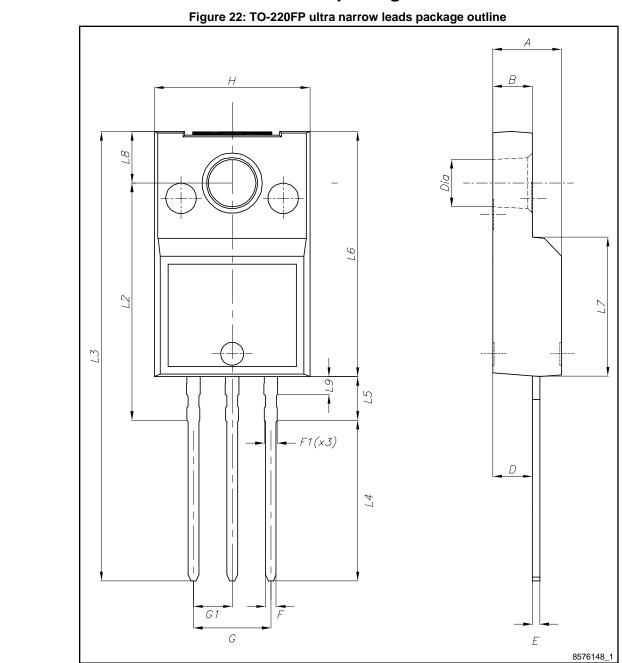
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Package information

Table 9: TO-220FP package mechanical data						
Dim.	mm					
Dim.	Min.	Тур.	Max.			
A	4.4		4.6			
В	2.5		2.7			
D	2.5		2.75			
E	0.45		0.7			
F	0.75		1			
F1	1.15		1.70			
F2	1.15		1.70			
G	4.95		5.2			
G1	2.4		2.7			
Н	10		10.4			
L2		16				
L3	28.6		30.6			
L4	9.8		10.6			
L5	2.9		3.6			
L6	15.9		16.4			
L7	9		9.3			
Dia	3		3.2			





4.2 TO-220FP ultra narrow leads package information



Package information

Table 10: TO-220FP ultra narrow leads mechanical data					
Dim.		mm			
Dim.	Min.	Тур.	Max.		
A	4.40		4.60		
В	2.50		2.70		
D	2.50		2.75		
E	0.45		0.60		
F	0.65		0.75		
F1	-		0.90		
G	4.95		5.20		
G1	2.40	2.54	2.70		
н	10.00		10.40		
L2	15.10		15.90		
L3	28.50		30.50		
L4	10.20		11.00		
L5	2.50		3.10		
L6	15.60		16.40		
L7	9.00		9.30		
L8	3.20		3.60		
L9	-		1.30		
Dia.	3.00		3.20		



5 Revision history

Table 11: Document revision history

Date	Revision	Changes
23-Jun-2014	1	First release.
13-Aug-2014	2	-Document status promoted from preliminary to production data. -Inserted Section 3: Electrical characteristics (curves). -Minor text changes.
17-Sep-2014	3	Updated title, features and description in cover page.
05-Nov-2014	4	Updated Section 3: Electrical characteristics (curves). Minor text changes.
08-Sep-2016	5	Added the order code STFU10N80K5 and the relative Section 4.2: "TO-220FP ultra narrow leads package information".



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